

MOSFET

OptiMOS™ 6 Power-Transistor, 150 V

Features

- N-channel, normal level
- Very low on-resistance R_{DS(on)}
- Superior thermal resistance
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21
- MSL 1 classified according to J-STD-020

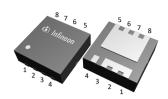
Product validation

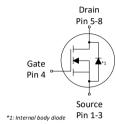
Fully qualified according to JEDEC for Industrial Applications

Key Performance Parameters Table 1

Parameter	Value	Unit
$V_{ m DS}$	150	V
R _{DS(on),max}	17.3	mΩ
I_{D}	48	А
Q _{oss}	45	nC
Q_{G}	14.8	nC
Q _{rr} (500 A/μs)	101	nC











Type/Ordering Code	Package	Marking	Related Links
ISZ173N15NM6	PG-TSDSON-8	17315N6	-

Public

OptiMOS™ 6 Power-Transistor, 150 V ISZ173N15NM6



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1 Maximum ratings

at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Davamatav	Cymah al		Values			Nata/Tast Candition
Parameter	Symbol	Min.	Тур.	Мах.	Unit	Note/ Test Condition
Continuous drain current ¹⁾	I _D	-	-	48 34 32 7.9	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =8 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =60 °C/W ²⁾
Pulsed drain current ³⁾	I _{D,pulse}	-	-	192	А	T _C =25 °C
Avalanche current, single pulse ⁴⁾	I _{AS}	-	-	16	А	T _C =25 °C
Avalanche energy, single pulse	E _{AS}	-	-	140	mJ	$I_{\rm D}$ =7 A, $R_{\rm GS}$ =25 Ω
Gate source voltage	V_{GS}	-20	-	20	V	-
Power dissipation	$P_{\rm tot}$	-	-	94 2.5	W	$T_{\rm C}$ =25 °C $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =60 °C/W ²⁾
Operating and storage temperature	$T_{\rm j}$, $T_{\rm stg}$	-55	-	175	°C	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			l loit	Note / Took Condition
Parameter	Symbol	Min.	Тур.	Мах.	Unit	Note/ Test Condition
Thermal resistance, junction - case	R_{thJC}	-	-	1.6	°C/W	-
Thermal resistance, junction -						
ambient,	R_{thJA}	-	-	60	°C/W	-
6 cm ² cooling area ⁵⁾						

⁵⁾ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 μm thick) copper area for drain connection. PCB is vertical in still air.

²⁾ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 μm thick) copper area for drain connection. PCB is vertical in still air.

³⁾ See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information



3 Electrical characteristics

at $T_{\rm j}$ =25 °C, unless otherwise specified

Table 4 Static characteristics

Parameter	Symbol	Values			Unit	Nata/Task Condition
raiailletei	Syllibol	Min.	Тур.	Мах.		Note/ Test Condition
Drain-source breakdown voltage	$V_{(BR)DSS}$	150	-	-	V	$V_{\rm GS}$ =0 V, $I_{\rm D}$ =1 mA
Gate threshold voltage	$V_{\rm GS(th)}$	3.0	3.5	4.0	V	$V_{\rm DS} = V_{\rm GS}$, $I_{\rm D} = 35 \mu\text{A}$
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μΑ	$V_{\rm DS}$ =120 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C $V_{\rm DS}$ =120 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =125 °C
Gate-source leakage current	I_{GSS}	-	10	100	nA	$V_{\rm GS}$ =20 V, $V_{\rm DS}$ =0 V
Drain-source on-state resistance	$R_{\mathrm{DS(on)}}$	-	15.3	16.3 17.3 20.2	mΩ	V_{GS} =15 V, I_D =16 A V_{GS} =10 V, I_D =16 A V_{GS} =8 V, I_D =8 A
Gate resistance	R_{G}	-	0.82	1.23	Ω	-
Transconductance	g_{fs}	14	27	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 16 A$

Table 5 Dynamic characteristics

Doromotor	Symbol	Values			Unit	Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Мах.	Unit	Note/ Test Condition	
Input capacitance ⁶⁾	C _{iss}	-	1000	1300	pF	V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz	
Output capacitance ⁶⁾	C _{oss}	-	330	430	pF	V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz	
Reverse transfer capacitance ⁶⁾	C _{rss}	-	9	14	pF	V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz	
Turn-on delay time	$t_{d(on)}$	-	7	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =8 A, $R_{\rm G,ext}$ =1.	
Rise time	t _r	-	2	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =8 A, $R_{\rm G,ext}$ =1. 6 Ω	
Turn-off delay time	$t_{\sf d(off)}$	-	9	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =8 A, $R_{\rm G,ext}$ =1.	
Fall time	t _f	-	11	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =8 A, $R_{\rm G,ext}$ =1.	

⁶⁾ Defined by design. Not subject to production test.



Table 6 Gate charge characteristics 7)

Parameter	Symbol	Values			Unit	Note/Test Condition	
raiailietei	Symbol	Min.	Тур.	Мах.	Oilit	Note/ Test Condition	
Gate to source charge ⁸⁾	$Q_{ m gs}$	-	5.5	7.2	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =8 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge at threshold	$Q_{\mathrm{g(th)}}$	-	3.6	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =8 A, $V_{\rm GS}$ =0 to 10 V	
Gate to drain charge ⁸⁾	Q_{gd}	-	3.8	5.7	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =8 A, $V_{\rm GS}$ =0 to 10 V	
Switching charge	Q_{sw}	-	5.7	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =8 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge total ⁸⁾	Q_{g}	-	14.8	19.2	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =8 A, $V_{\rm GS}$ =0 to 10 V	
Gate plateau voltage	$V_{ m plateau}$	-	5.4	-	V	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =8 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge total, sync. FET	$Q_{g(sync)}$	-	12	-	nC	$V_{\rm DS}$ =0.1 V, $V_{\rm GS}$ =0 to 10 V	
Output charge ⁸⁾	$Q_{ m oss}$	-	45	59	nC	V _{DS} =75 V, V _{GS} =0 V	

 $^{^{7)} \;\;}$ See "Gate charge waveforms" for parameter definition

Table 7 Reverse diode

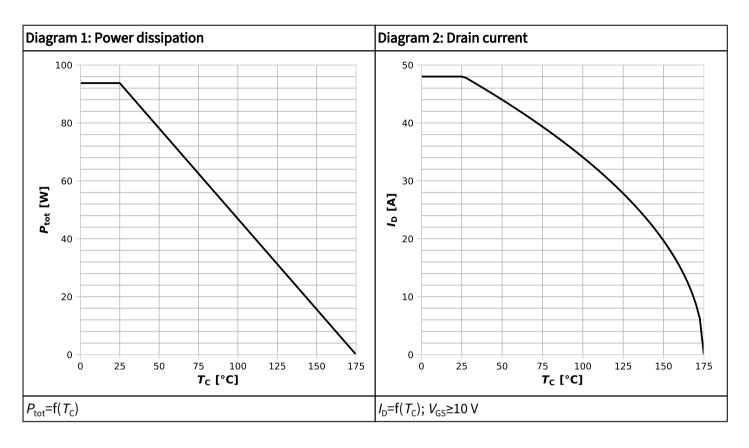
Parameter	Symbol	Values			Unit	Note/ Test Condition	
raiailletei	Syllibot	Min.	Тур.	Max.	Oilit	inote/ rest condition	
Diode continuous forward current	Is	-	-	48	А	<i>T</i> _c =25 °C	
Diode pulse current	I _{S,pulse}	-	-	192	А	<i>T</i> _c =25 °C	
Diode forward voltage	$V_{\rm SD}$	-	0.85	1.0	V	$V_{\rm GS}$ =0 V, $I_{\rm F}$ =16 A, $T_{\rm j}$ =25 °C	
Reverse recovery time ⁹⁾	t _{rr}	-	31	62	ns	$V_{\rm R}$ =75 V, $I_{\rm F}$ =8 A, d $i_{\rm F}$ /d t =500 A/ μ s	
Reverse recovery charge ⁹⁾	$Q_{\rm rr}$	-	101	202	nC	$V_{\rm R}$ =75 V, $I_{\rm F}$ =8 A, d $i_{\rm F}$ /d t =500 A/ μ s	
Reverse recovery time ⁹⁾	t _{rr}	-	21	42	ns	$V_{\rm R}$ =75 V, $I_{\rm F}$ =8 A, d $I_{\rm F}$ /d t =1000 A/ μ s	
Reverse recovery charge ⁹⁾	$Q_{\rm rr}$	_	128	256	nC	$V_{\rm R}$ =75 V, $I_{\rm F}$ =8 A, d $I_{\rm F}$ /d t =1000 A/ μ s	

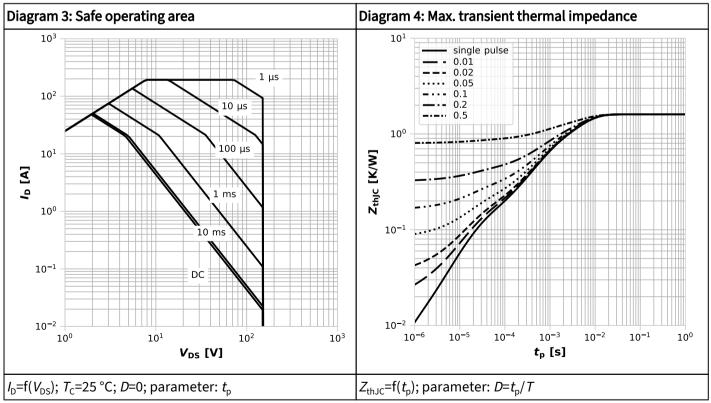
⁹⁾ Defined by design. Not subject to production test.

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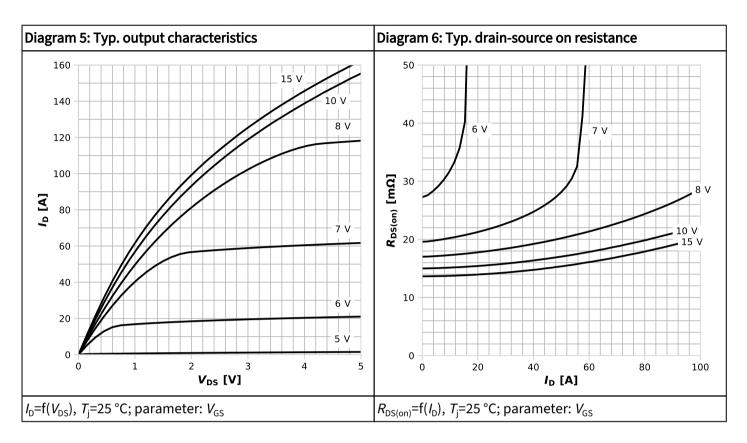


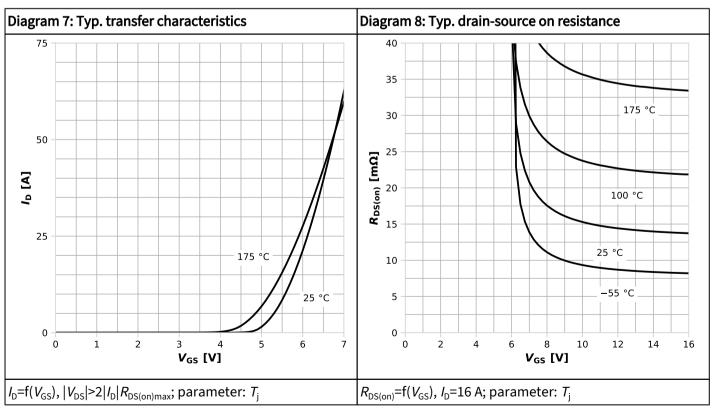
4 Electrical characteristics diagrams



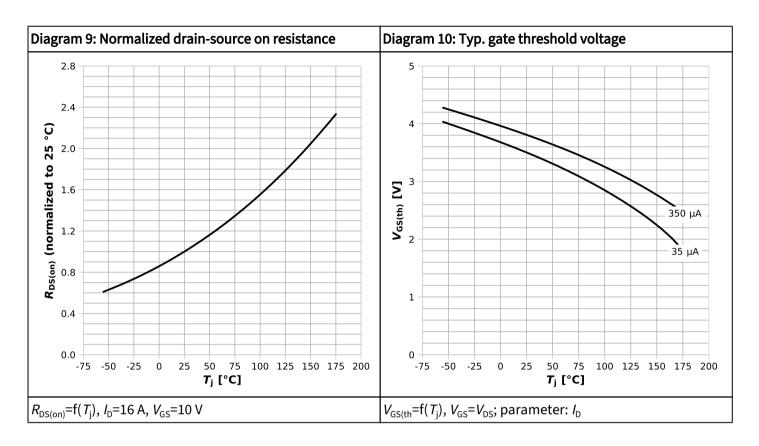


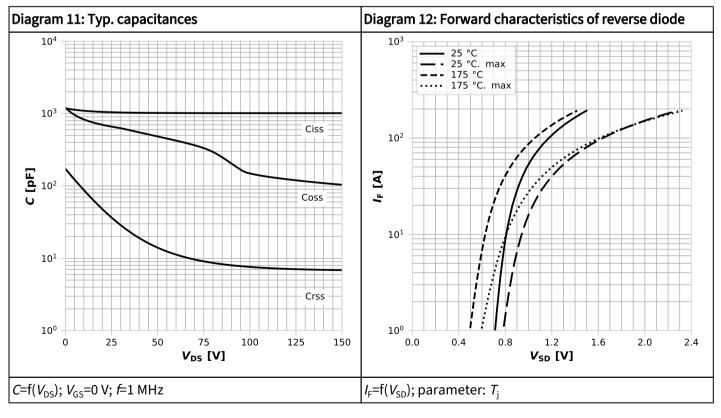




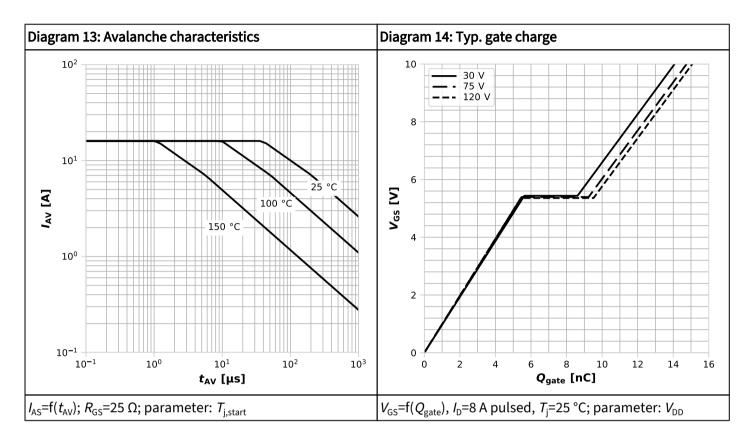


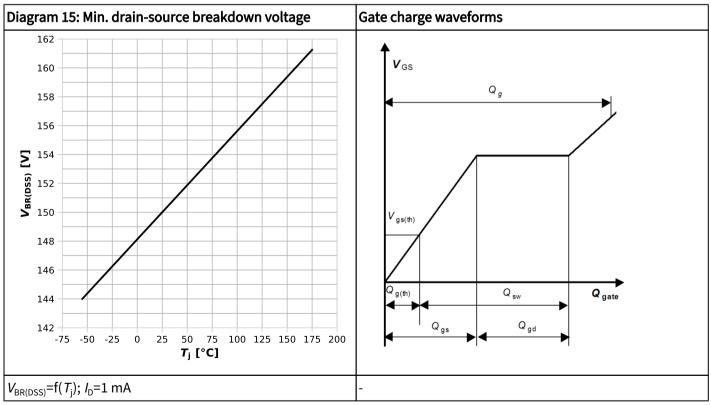






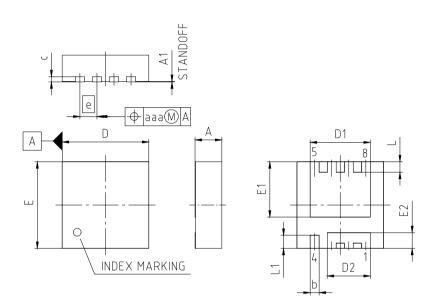








5 Package Outlines



PACKAGE - GROUP NUMBER:	PG-TSDS	PG-TSDSON-8-U03						
DIMENSIONS	MILLIMETERS							
DIMENSIONS	MIN.	MAX.						
Α	0.90	1.10						
A1	0	0.05						
b	0.24	0.44						
С	0.10	0.30						
D	3.20	3.40						
D1	2.19	2.39						
D2	1.54	1.74						
E	3.20	3.40						
E1	2.01	2.21						
E2	0.50	0.70						
е	0.65							
L	0.30 0.50							
L1	0.40 0.60							
aaa	0.0	06						
N	8	1						

NOTE:

DIMENSIONS DO NOT INCLUDE MOLD FLASH, PROTRUSION OR GATE BURRS

Figure 1 Outline PG-TSDSON-8, dimensions in mm



Revision History

ISZ173N15NM6

Revision 2024-04-22, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)
1.0	2024-03-15	Release of preliminary version
2.0	2024-04-22	Release of final

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